

E 70/33/32 Core and accessories

 Series/Type:
 B66371, B66372

 Date:
 April 2018

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E 70/33/32

Core

B66371

- 32-0.8

FEK0151-X

- 70,5 ±1 -

22_{-0,7}=| 48^{+1,5} -

5 1

Delivery mode: single units

Magnetic characteristics (per set)

$$\begin{split} \Sigma I/A &= 0.22 \text{ mm}^{-1} \\ I_e &= 149 \text{ mm} \\ A_e &= 683 \text{ mm}^2 \\ A_{min} &= 676 \text{ mm}^2 \\ V_e &= 102000 \text{ mm}^3 \end{split}$$

Approx. weight 514 g/set

Ungapped

Mate- rial	A _L value nH	μ _e	B _S * mT	P _V W/set	Ordering code
N27	8850 +30/-20%	1530	320	< 19.00 (200 mT, 25 kHz, 100 °C)	B66371G0000X127
N87	9700 +30/-20%	1700	320	< 9.50 (100 mT, 100 kHz, 100 °C)	B66371G0000X187
N97	10000+30/-20%	1740	330	< 8.60 (100 mT, 100 kHz, 100 °C)	B66371G0000X197
N95	13000+30/-20%	2260	330	< 11.30 (100 mT, 100 kHz, 25 °C) < 9.00 (100 mT, 100 kHz, 100 °C)	B66371G0000X195

* H = 250 A/m; f = 10 kHz; T = 100 °C

Gapped (A_L values/air gaps examples)

Material	g mm	A _L value approx. nH	μ _e	Ordering code
N27	1.50 ±0.05	655	113	B66371G1500X127
N87	$\begin{array}{c} 2.00 \pm \! 0.05 \\ 2.50 \pm \! 0.05 \\ 4.00 \pm \! 0.05 \end{array}$	520 435 200	90 75 35	B66371G2000X187 B66371G2500X187 B66371G4000X187

The A_L value in the table applies to a core set comprising one ungapped core (dimension g = 0 mm) and one gapped core (dimension g > 0 mm).

Other AL values/air gaps and materials available on request - see Processing remarks on page 5.



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Core

B66371

Material	Relationship air gap – A _L		Calculation o	f saturation cu	rrent	
	K1 (25 °C)	K2 (25 °C)	K3 (25 °C)	K4 (25 °C)	K3 (100 °C)	K4 (100 °C)
N27	903	-0.789	1568	-0.847	1470	-0.865
N87	903	-0.789	1485	-0.796	1438	-0.873

Validity range: K1, K2: 0.20 mm < s < 5.00 mm K3, K4: 290 nH < A_L < 2880 nH



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		CU

Accessories

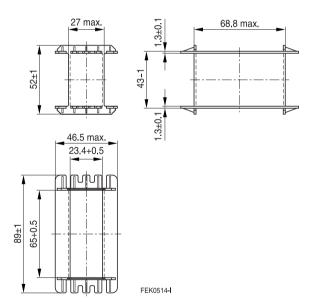
B66372

Coil former

Material:	B66372A:	Polyphenylene suplhide, UL 94 V-0, insulation class to IEC 60085:
		$F \cong max.$ operating temperature 155 °C), color code natur
		Ryton R-4-280 [E95746 (M)] SOLVAY SPECIALITY POLYMERS
	B66372B:	GFR ASA/ PBT, UL 94 HB, insulation class to IEC 60085:
		H ≙ max. operating temperature 130 °C), color code black
		Ultradur 4090G6 [E41871 (M)], BASF SE
Winding:	see Proces	ssing notes 21

Winding: see Processing notes, 2.1

Sections	A _N mm ²	l _N mm	A_R value $\mu\Omega$	Pins	Ordering code
1	389	230.5	20	-	B66372A2000T001 B66372B2000T001





Cautions and warnings

Mechanical stress and mounting

Ferrite cores have to meet mechanical requirements during assembling and for a growing number of applications. Since ferrites are ceramic materials one has to be aware of the special behavior under mechanical load.

As valid for any ceramic material, ferrite cores are brittle and sensitive to any shock, fast temperature changing or tensile load. Especially high cooling rates under ultrasonic cleaning and high static or cyclic loads can cause cracks or failure of the ferrite cores.

For detailed information see data book, chapter "General - Definitions, 8.1".

Effects of core combination on AL value

Stresses in the core affect not only the mechanical but also the magnetic properties. It is apparent that the initial permeability is dependent on the stress state of the core. The higher the stresses are in the core, the lower is the value for the initial permeability. Thus the embedding medium should have the greatest possible elasticity.

For detailed information see data book, chapter "General - Definitions, 8.1".

Heating up

Ferrites can run hot during operation at higher flux densities and higher frequencies.

NiZn-materials

The magnetic properties of NiZn-materials can change irreversible in high magnetic fields.

Ferrite Accessories

EPCOS ferrite accessories have been designed and evaluated only in combination with EPCOS ferrite cores. EPCOS explicitly points out that EPCOS ferrite accessories or EPCOS ferrite cores may not be compatible with those of other manufacturers. Any such combination requires prior testing by the customer and will be at the customer's own risk.

EPCOS assumes no warranty or reliability for the combination of EPCOS ferrite accessories with cores and other accessories from any other manufacturer.

Processing remarks

The start of the winding process should be soft. Else the flanges may be destroyed.

- Too strong winding forces may blast the flanges or squeeze the tube that the cores can not be mounted any more.
- Too long soldering time at high temperature (>300 °C) may effect coplanarity or pin arrangement.
- Not following the processing notes for soldering of the J-leg terminals may cause solderability problems at the transformer because of pollution with Sn oxyde of the tin bath or burned insulation of the wire. For detailed information see chapter "Processing notes", section 2.2.
- The dimensions of the hole arrangement have fixed values and should be understood as a recommendation for drilling the printed circuit board. For dimensioning the pins, the group of holes can only be seen under certain conditions, as they fit into the given hole arrangement. To avoid problems when mounting the transformer, the manufacturing tolerances for positioning the customers' drilling process must be considered by increasing the hole diameter.



Cautions and warnings

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Symbols and terms

Symbol	Meaning	Unit
A	Cross section of coil	mm ²
A _e	Effective magnetic cross section	mm ²
AL	Inductance factor; $A_L = L/N^2$	nH
A _{L1}	Minimum inductance at defined high saturation ($\cong \mu_a$)	nH
A _{min}	Minimum core cross section	mm ²
A _N	Winding cross section	mm ²
A _R	Resistance factor; $A_R = R_{Cu}/N^2$	μΩ = 10 ^{–6} Ω
В	RMS value of magnetic flux density	Vs/m², mT
ΔB	Flux density deviation	Vs/m², mT
Ê	Peak value of magnetic flux density	Vs/m², mT
ΔÂ	Peak value of flux density deviation	Vs/m², mT
B _{DC}	DC magnetic flux density	Vs/m², mT
B _R	Remanent flux density	Vs/m², mT
B _S	Saturation magnetization	Vs/m², mT
C ₀	Winding capacitance	F = As/V
CDF	Core distortion factor	mm ^{-4.5}
DF	Relative disaccommodation coefficient DF = d/μ_i	
d	Disaccommodation coefficient	
Ea	Activation energy	J
f	Frequency	s−1, Hz
f _{cutoff}	Cut-off frequency	s−1, Hz
f _{max}	Upper frequency limit	s−1, Hz
f _{min}	Lower frequency limit	s−1, Hz
f _r	Resonance frequency	s−1, Hz
f _{Cu}	Copper filling factor	
g	Air gap	mm
H	RMS value of magnetic field strength	A/m
Ĥ	Peak value of magnetic field strength	A/m
H _{DC}	DC field strength	A/m
H _c	Coercive field strength	A/m
h	Hysteresis coefficient of material	10 ^{–6} cm/A
h/μ _i ²	Relative hysteresis coefficient	10 ^{–6} cm/A
I	RMS value of current	A
I _{DC}	Direct current	A
Î	Peak value of current	А
J	Polarization	Vs/m ²
k	Boltzmann constant	J/K
k ₃	Third harmonic distortion	
k _{3c}	Circuit third harmonic distortion	
L	Inductance	H = Vs/A



Symbols and terms

Symbol	Meaning	Unit
ΔL/L	Relative inductance change	Н
L ₀	Inductance of coil without core	н
L _H	Main inductance	н
Lp	Parallel inductance	н
L _{rev}	Reversible inductance	н
Ls	Series inductance	н
l _e	Effective magnetic path length	mm
I _N	Average length of turn	mm
N	Number of turns	
P _{Cu}	Copper (winding) losses	W
Ptrans	Transferrable power	W
Pv	Relative core losses	mW/g
PF	Performance factor	
Q	Quality factor (Q = $\omega L/R_s$ = 1/tan δ_L)	
R	Resistance	Ω
R _{Cu}	Copper (winding) resistance (f = 0)	Ω
R _h	Hysteresis loss resistance of a core	Ω
ΔR_h	R _h change	Ω
R _i	Internal resistance	Ω
R _p	Parallel loss resistance of a core	Ω
Rs	Series loss resistance of a core	Ω
R _{th}	Thermal resistance	K/W
R _V	Effective loss resistance of a core	Ω
s	Total air gap	mm
Т	Temperature	°C
ΔT	Temperature difference	К
т _с	Curie temperature	°C
t	Time	s
t _v	Pulse duty factor	
tan δ	Loss factor	
tan δ _l	Loss factor of coil	
tan δ _r	(Residual) loss factor at $H \rightarrow 0$	
tan δ _e	Relative loss factor	
tan δ _h	Hysteresis loss factor	
tan δ/μ _i	Relative loss factor of material at $H \rightarrow 0$	
U	RMS value of voltage	V
Û	Peak value of voltage	V
Ve	Effective magnetic volume	mm ³
z	Complex impedance	Ω
Zn	Normalized impedance $ Z _n = Z / N^2 \times \varepsilon (I_e / A_e)$	Ω/mm



Symbols and terms

Symbol	Meaning	Unit
α	Temperature coefficient (TK)	1/K
α _F	Relative temperature coefficient of material	1/K
α _e	Temperature coefficient of effective permeability	1/K
ε _r	Relative permittivity	
Φ	Magnetic flux	Vs
η	Efficiency of a transformer	
JB	Hysteresis material constant	mT-1
η _i	Hysteresis core constant	A-1H-1/2
λ _s	Magnetostriction at saturation magnetization	
μ	Relative complex permeability	
μο	Magnetic field constant	Vs/Am
Ja	Relative amplitude permeability	
u _{app}	Relative apparent permeability	
ue.	Relative effective permeability	
ι _i	Relative initial permeability	
up'	Relative real (inductive) component of $\overline{\mu}$ (for parallel components)	
ι _p "	Relative imaginary (loss) component of $\overline{\mu}$ (for parallel components)	
ι Ir	Relative permeability	
lrev	Relative reversible permeability	
us'	Relative real (inductive) component of $\overline{\mu}$ (for series components)	
μ _s "	Relative imaginary (loss) component of $\overline{\mu}$ (for series components)	
^μ tot	Relative total permeability	
	derived from the static magnetization curve	
5	Resistivity	Ωm^{-1}
ΣI/A	Magnetic form factor	mm ⁻¹
^r Cu	DC time constant $\tau_{Cu} = L/R_{Cu} = A_L/A_R$	s
Ð	Angular frequency; $\omega = 2 \Pi f$	s-1

All dimensions are given in mm.

Surface-mount device



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Release 2018-10